

54VHC/74VHC139 Dual 2-to-4 Decoder/Demultiplexer



February 1993

T-67-21-55

# 54VHC/74VHC139 Dual 2-to-4 Decoder/Demultiplexer

## General Description

The VHC139 is an advanced high speed CMOS 2 to 4 line decoder/demultiplexer fabricated with silicon gate CMOS technology.

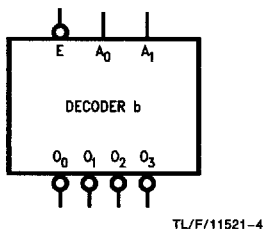
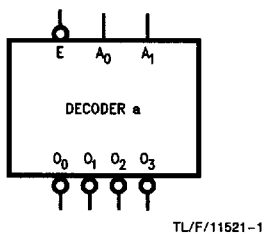
It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The active low enable input can be used for gating or it can be used as a data input for demultiplexing applications. When the enable input is held High, all four outputs are fixed at a high logic level independent of the other inputs. An input protection circuit ensures that 0V to 7V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

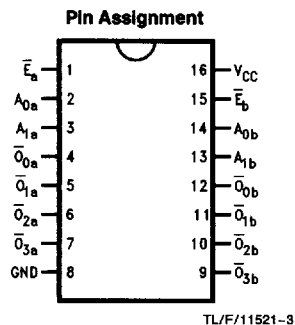
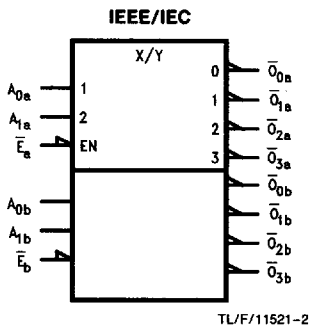
## Features

- High speed:  $t_{PD} = 5.0 \text{ ns (Typ.)}$  at  $V_{CC} = 5V$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (Max.)}$  at  $T_A = 25^\circ C$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC} \text{ (Min.)}$
- All inputs are equipped with a power down protection function
- Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- Wide operating voltage range:  $V_{CC} \text{ (opr)} = 2V \sim 5.5V$
- Pin and function compatible with 74HC139

## Logic Symbols



## Connection Diagram



Pin Names	Description
$A_0, A_1$	Address Inputs
$\bar{E}$	Enable Inputs
$\bar{O}_0 - \bar{O}_3$	Outputs

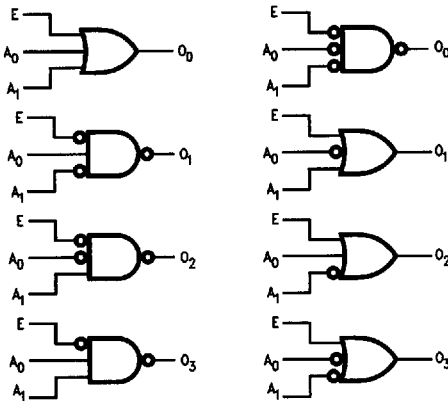
### Functional Description

The VHC139 is a high-speed dual 2-to-4 decoder/demultiplexer. The device has two independent decoders, each of which accepts two binary weighted inputs ( $A_0-A_1$ ) and provides four mutually exclusive active-LOW outputs ( $\bar{O}_0-\bar{O}_3$ ). Each decoder has an active-LOW enable ( $\bar{E}$ ). When  $\bar{E}$  is HIGH all outputs are forced HIGH. The enable can be used as the data input for a 4-output demultiplexer application. Each half of the VHC139 generates all four minterms of two variables. These four minterms are useful in some applications, replacing multiple gate functions as shown in Figure 1, and thereby reducing the number of packages required in a logic network.

### Truth Table

Inputs			Outputs			
$\bar{E}$	$A_0$	$A_1$	$\bar{O}_0$	$\bar{O}_1$	$\bar{O}_2$	$\bar{O}_3$
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	H	L	H	L	H	H
L	L	H	H	H	L	H
L	H	H	H	H	H	L

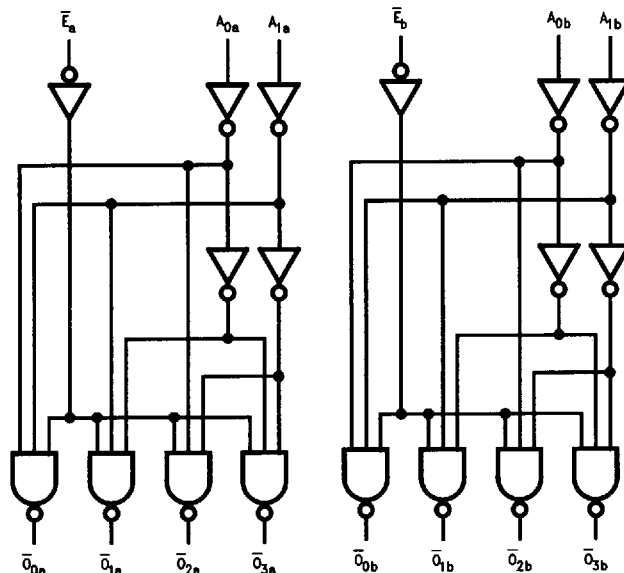
H = HIGH Voltage Level  
 L = LOW Voltage Level  
 X = Immaterial



TL/F/11521-8

FIGURE 1. Gate Functions (Each Half)

### Logic Diagram



TL/F/11521-9

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

**Absolute Maximum Ratings** (Note)

Supply Voltage (V <sub>CC</sub> )	-0.5V to +7.0V
DC Input Voltage (V <sub>IN</sub> )	-0.5V to +7.0V
DC Output Voltage (V <sub>OUT</sub> )	-0.5V to V <sub>CC</sub> + 0.5V
Input Diode Current (I <sub>IK</sub> )	-20 mA
Output Diode Current (I <sub>OK</sub> )	±20 mA
DC Output Current (I <sub>OUT</sub> )	±25 mA
DC V <sub>CC</sub> /GND Current (I <sub>CC</sub> )	±75 mA
Storage Temperature (T <sub>STG</sub> )	-65°C to +150°C
Lead Temperature (T <sub>L</sub> ) (Soldering, 10 sec.)	300°C

Note: *Absolute Maximum Ratings* are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation outside databook specifications.

**Recommended Operating Conditions**

Supply Voltage (V <sub>CC</sub> )	2.0V to +5.5V
Input Voltage (V <sub>IN</sub> )	0V to +5.5V
Output Voltage (V <sub>OUT</sub> )	0V to V <sub>CC</sub>
Operating Temperature (T <sub>OPR</sub> )	
54VHC	-55°C to +125°C
74VHC	-40°C to +85°C
Input Rise and Fall Time (t <sub>r</sub> , t <sub>f</sub> )	
V <sub>CC</sub> = 3.3V ±0.3V	0 ~ 100 ns/V
V <sub>CC</sub> = 5.0V ±0.5V	0 ~ 20 ns/V

**DC Characteristics for 'VHC Family Devices**

Symbol	Parameter	V <sub>CC</sub> (V)	74VHC		54VHC		74VHC		Units	Conditions	
			T <sub>A</sub> = 25°C			T <sub>A</sub> = -55°C to +125°C		T <sub>A</sub> = -40°C to +85°C			
			Min	Typ	Max	Min	Max	Min			Max
V <sub>IH</sub>	High Level Input Voltage	2.0 3.0-5.5	1.50	0.7 V <sub>CC</sub>		1.50	0.7 V <sub>CC</sub>		V		
V <sub>IL</sub>	Low Level Input Voltage	2.0 3.0-5.5	0.50 0.3 V <sub>CC</sub>		0.50 0.3 V <sub>CC</sub>		0.50 0.3 V <sub>CC</sub>		V		
V <sub>OH</sub>	High Level Output Voltage	2.0	1.9	2.0	1.9	1.9	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		V	I <sub>OH</sub> = -50 μA	
		3.0	2.9	3.0	2.9	2.9	I <sub>OH</sub> = -4 mA				
		4.5	4.4	4.5	4.4	4.4		I <sub>OH</sub> = -8 mA			
V <sub>OL</sub>	Low Level Output Voltage	3.0	2.58		2.40	2.48			V	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA
		4.5	3.94		3.70	3.80					
		3.0	0.36		0.50	0.44		I <sub>OL</sub> = 4 mA			
4.5	0.36		0.50	0.44		I <sub>OL</sub> = 8 mA					
I <sub>IN</sub>	Input Leakage Current	0-5.5	±0.1		±1.0		±1.0		μA	V <sub>IN</sub> = 5.5V or GND	
I <sub>CC</sub>	Quiescent Supply Current	5.5	4.0		80.0		40.0		μA	V <sub>IN</sub> = V <sub>CC</sub> or GND	

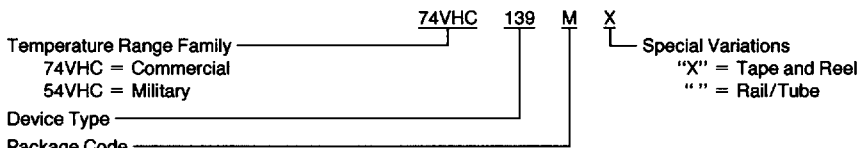
## AC Electrical Characteristics

Symbol	Parameter	V <sub>CC</sub> (V)	74VHC			54VHC		74VHC	
			T <sub>A</sub> = 25°C			T <sub>A</sub> = -55°C to +125°C		T <sub>A</sub> = -40°C to +85°C	
			Min	Typ	Max	Min	Max	Min	Max
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay A <sub>n</sub> to $\bar{O}_n$	3.3 ± 0.3	7.2	11.0			1.0	13.0	
		5.0 ± 0.5	9.7	14.5			1.0	16.5	
			5.0	7.2			1.0	8.5	
			6.5	9.2			1.0	10.5	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay $\bar{E}_n$ to $\bar{O}_n$	3.3 ± 0.3	6.4	9.2			1.0	11.0	
		5.0 ± 0.5	8.9	12.7			1.0	14.5	
			4.4	6.3			1.0	7.5	
			5.9	8.3			1.0	9.5	
C <sub>IN</sub>	Input Capacitance		4	10				10	
C <sub>PD</sub>	Power Dissipation Capacitance		26						

Note 1: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC</sub> (opr.) = C<sub>PD</sub> \* V<sub>CC</sub> \* f<sub>IN</sub> + I<sub>CC</sub>/2 (per decoder).

## Ordering Information

The device number is used to form part of a simplified purchasing code, where the package type and temperature range are defined as follows:

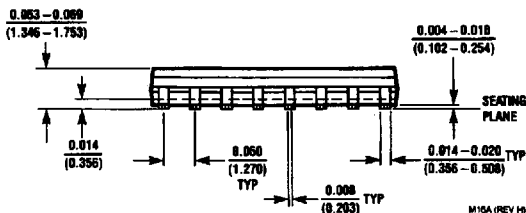
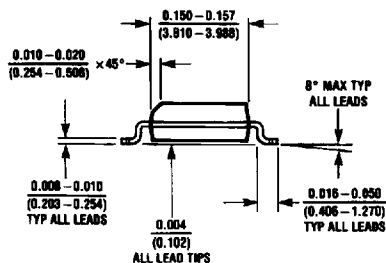
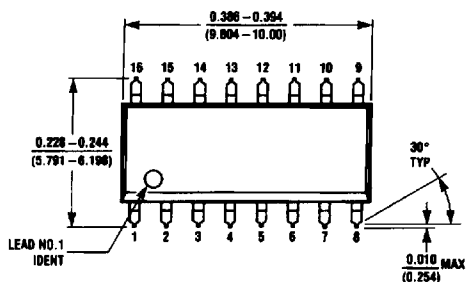


M = Small Outline JEDEC SOIC  
 SJ = Small Outline EIAJ SOIC  
 MSC = Shrink Small Outline EIAJ SSOP Type 1  
 J/883 = Ceramic DIP  
 W/883 = Ceramic Flatpak  
 E/883 = Leadless Ceramic Chip Carrier

NATL SEMICOND (MEMORY)

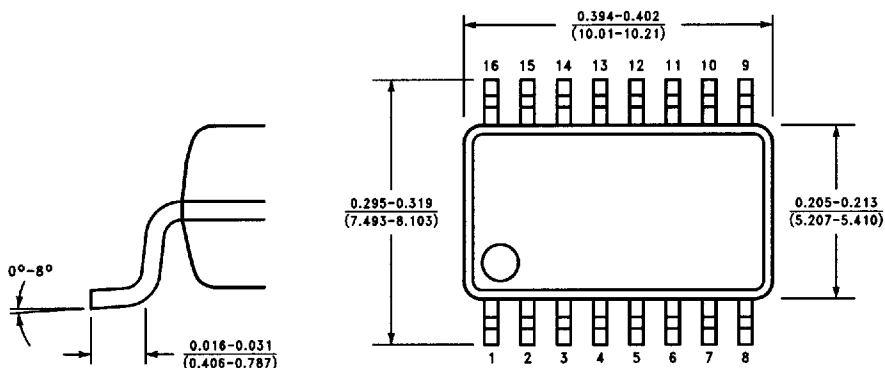
**Physical Dimensions** inches (millimeters)

NATL SEMICON (MEMORY)

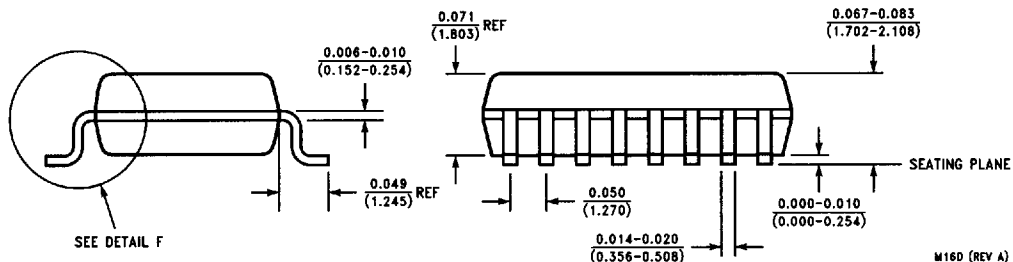


M16A (REV 14)

**16-Lead Small Outline Integrated Circuit JEDEC SOIC (M)  
NS Package Number M16A**



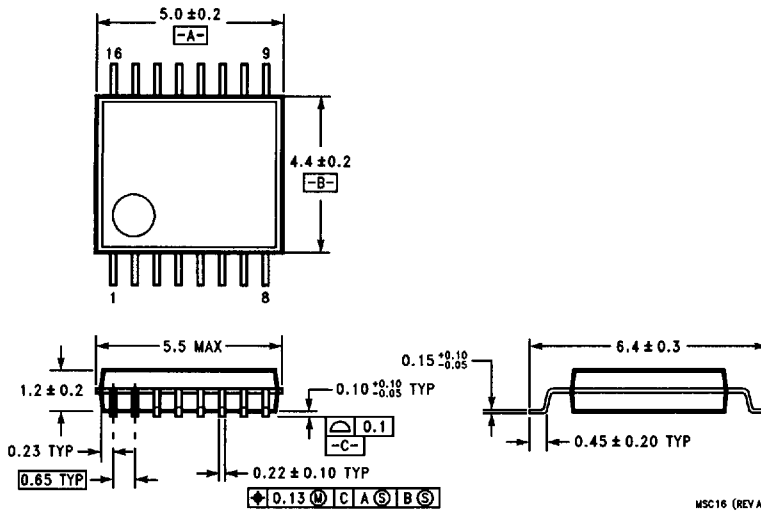
**DETAIL F**



M16D (REV A)

**16-Lead Plastic-EIAJ SOIC (SJ)  
NS Package Number M16D**

## Physical Dimensions inches (millimeters) (Continued)



16-Lead Plastic EIAJ SSOP Type I (MSC)  
NS Package Number MSC16

NATL SEMICOND (MEMORY)

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National Semiconductor Corporation  
2900 Semiconductor Drive  
P.O. Box 59090  
Santa Clara, CA 95052-9090  
Tel: (408) 272-9959  
TWX: (910) 339-9240

National Semiconductor GmbH  
Industriestrasse 10  
D-8060 Fürstentfeldbruck  
Germany  
Tel: (0-81-41) 103-0  
Telex: 527849  
Fax: (0-81-41) 10-35-06

National Semiconductor Japan Ltd.  
Sanseido Bldg. 5F  
4-15-3 Nishi Shinjuku  
Shinjuku-Ku,  
Tokyo 160, Japan  
Tel: 3-3299-7001  
FAX: 3-3299-7000

National Semiconductor Hong Kong Ltd.  
13th Floor, Straight Block  
Ocean Centre, 5 Canton Rd.  
Tsimshatsui, Kowloon  
Hong Kong  
Tel: (852) 737-1600  
Telex: 51292 NSHKL  
Fax: (852) 736-9960

National Semiconductores Do Brasil Ltda.  
Av. Bríg. Faria Lima, 1409  
6 Andar  
Cap-01451, Paulistano,  
Sao Paulo, SP, Brazil  
Tel: (55-11) 212-5066  
Telex: 391-1131931 NSBR BR  
Fax: (55-11) 212-1181

National Semiconductor (Australia) Pty, Ltd.  
16 Business Park Dr.  
Notting Hill, VIC 3168  
Australia  
Tel: (3) 558-9999  
Fax: (3) 558-9998